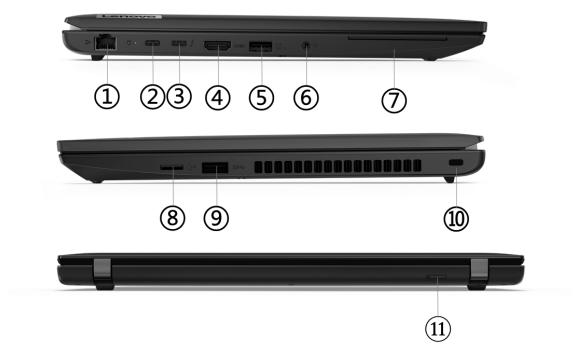
OVERVIEW



1. Ethernet (RJ-45)	7. Smart card reader *
2. USB-C 3.2 Gen 2	8. microSD card reader
3. Thunderbolt 4	9. USB 3.2 Gen 1
4. HDMI	10. Kensington Nano Security Slot
5. USB 3.2 Gen 1 (Always On)	11. Nano-SIM card slot *
6. Headphone / microphone combo jack (3.5mm)	

Notes:

• Items with * are only available on selected models

ThinkPad L14 Gen 4 (Intel)

PERFORMANCE

Processor

Processor Family

Intel® U-series or 13th Generation Intel® U or P Series Core i3 / i5 / i7 Processor

Processor**

Processor Name	Cores	Threads	Base Frequency	Base Frequency Max Frequency		Processor Graphics
U300	5 (1 P-core + 4 E- core)	6	P-core 1.2GHz / E-core 0.9GHz	P-core 4.4GHz / E-core 3.3GHz	8MB	Intel® UHD Graphics
Core i3-1315U	6 (2 P-core + 4 E- core)	8	P-core 1.2GHz / E-core 0.9GHz	P-core 4.5GHz / E-core 3.3GHz	10MB	Intel® UHD Graphics
Core i5-1335U	10 (2 P-core + 8 E-core)	12	P-core 1.3GHz / E-core 0.9GHz	P-core 4.6GHz / E-core 3.4GHz	12MB	Intel® Iris® Xe Graphics ^[1]
Core i5-1340P	12 (4 P-core + 8 E-core)	16	P-core 1.9GHz / E-core 1.4GHz	P-core 4.6GHz / E-core 3.4GHz	12MB	Intel® Iris® Xe Graphics ^[2]
Core i5-1345U	10 (2 P-core + 8 E-core)	12	P-core 1.6GHz / E-core 1.2GHz	P-core 4.7GHz / E-core 3.5GHz	12MB	Intel® Iris® Xe Graphics ^[3]
Core i5-1350P	12 (4 P-core + 8 E-core)	16	P-core 1.9GHz / E-core 1.4GHz	P-core 4.7GHz / E-core 3.5GHz	12MB	Intel® Iris® Xe Graphics ^[4]
Core i7-1355U	10 (2 P-core + 8 E-core)	12	P-core 1.7GHz / E-core 1.2GHz	P-core 5.0GHz / E-core 3.7GHz	12MB	Intel® Iris® Xe Graphics ^[5]
Core i7-1360P	12 (4 P-core + 8 E-core)	16	P-core 2.2GHz / E-core P-core 5.0GHz / E-cor 1.6GHz 3.7GHz		18MB	Intel® Iris® Xe Graphics ^[6]
Core i7-1365U	10 (2 P-core + 8 E-core)	12	P-core 1.8GHz / E-core 1.3GHz	P-core 5.2GHz / E-core 3.9GHz	12MB	Intel® Iris® Xe Graphics ^[7]
Core i7-1370P	14 (6 P-core + 8 E-core)	20	P-core 1.9GHz / E-core 1.4GHz	P-core 5.2GHz / E-core 3.9GHz	24MB	Intel® Iris® Xe Graphics ^[8]
Core 3 100U	6 (2 P-core + 4 E- core)	8	P-core 1.2GHz / E-core 900MHz	P-core 4.7GHz / E-core 3.3GHz	10MB	Intel [®] Graphics

Notes:

[1], [2], [3], [4], [5], [6], [7], [8] Intel[®] Iris[®] Xe Graphics capability requires system to be configured with dual-channel memory. On the system with single-channel memory, Intel[®] Iris[®] Xe Graphics will function as Intel[®] UHD Graphics.

Operating System

Operating System**

- Windows® 11 Pro
- Windows® 11 Home
- Windows® 11 Home Single Language
- Windows® 11 DG Windows® 10 Pro 64^[1]
- Ubuntu Linux^[2]
- Linux^[3]
- No preload operating system

Notes:

[1] Windows $^{\rm e}$ 11 DG Windows $^{\rm e}$ 10 Pro 64 is for special bid only.

[2], [3] Some features may not be supported on the system with Linux preload, including but not limited to Intel® RST RAID, MIPI computer vision camera, WWAN, Human Presence Detection, etc.

Graphics

Graphics**

Graphics	Туре	Memory	TGP	Key Features
Intel [®] UHD Graphics	Integrated	Shared	Share CPU TDP	DirectX® 12.1

Lenovo

Intel [®] Iris [®] Xe Graphics ^[1]	Integrated	Shared	Share CPU TDP	DirectX® 12.1
Intel [®] Graphics	Integrated	Shared	Share CPU TDP	DirectX® 12.1
NVIDIA [®] GeForce MX550 ^[2]	Discrete	2GB GDDR6	-	DirectX® 12

Notes:

[1] Intel[®] Iris[®] Xe Graphics capability requires system to be configured with dual-channel memory. On the system with single-channel memory, Intel[®] Iris[®] Xe Graphics will function as Intel[®] UHD Graphics.
 [2] NVIDIA[®] GeForce MX550 is NOT available in EMEA.

Monitor Support

Monitor Support

Supports up to 4 independent displays (native display and 3 external monitors via HDMI®, USB-C® and Thunderbolt™) • HDMI® supports up to 3840x2160@60Hz

• USB-C[®] supports up to 5120x3200@60Hz

• Thunderbolt[™] supports up to 5120x3200@60Hz

Chipset

Chipset

Intel® SoC (System on Chip) platform

Memory

Max Memory^[1]

Up to 64GB DDR4-3200

Memory Slots

Two DDR4 SO-DIMM slots, dual-channel capable

Memory Type

DDR4-3200

Notes:

[1] The max memory is based on the test results with current Lenovo® memory offerings.

Storage

Storage Support^[1]

One drive, up to 2TB M.2 2242 SSD

Storage Slot

One M.2 2242 PCIe[®] 4.0 x4 slot

Storage Type

D	Disk Type	Interface	Offering	Security
M.2	2 2242 SSD	PCIe® NVMe®, PCIe® 4.0 x4	256GB / 512GB / 1TB / 2TB	Opal 2.0

Notes:

[1] The storage capacity supported is based on the test results with current Lenovo® storage offerings.

Removable Storage

Card Reader

microSD card reader

Multi-Media

Audio Chip

- Non-vPro® models: High Definition (HD) Audio, Realtek® ALC3287 codec
- vPro $^{\circ}$ models: High Definition (HD) Audio, Senary SN6147 codec

Speakers

Stereo speakers, 2W x2, Dolby Audio™

Microphone

Dual-microphone array, far-field, Dolby Voice®

Camera**

- FHD 1080p + IR hybrid, with privacy shutter, fixed focus
- FHD 1080p, with privacy shutter, fixed focus
- HD 720p, with privacy shutter, fixed focus

Battery

Battery**[1]

- Integrated Li-Polymer 46.5Wh battery, supports Rapid Charge (charge up to 80% in 1hr) with 65W or 100W AC adapter
- Integrated Li-Polymer 57Wh battery, supports Rapid Charge (charge up to 80% in 1hr) with 65W or 100W AC adapter
- Integrated Li-Polymer 63Wh battery, supports Rapid Charge (charge up to 80% in 1hr) with 100W AC adapter

Battery Life^[2]

Configuration 1 (max battery life) MobileMark® 25: up to 14.38 hr @250nits JEITA 2.0: up to 27.39 hr @150nits Local video playback: up to 28.77 hr @150nits

Alternate configuration 2 MobileMark® 25: up to 9.35 hr @250nits JEITA 2.0: up to 16.86 hr @150nits Local video playback: up to 16.67 hr @150nits

Alternate configuration 3 MobileMark® 25: up to 7.6 hr @250nits JEITA 2.0: up to 15.38 hr @150nits Local video playback: up to 30.01 hr @150nits

Notes:

[1] Rapid charge is only guaranteed when the computer is turned off or in standby mode or in hibernation mode. When the computer is powered on, the Charge Time will vary depending on system power consumption and AC adapter power.
[2] Configuration 1 (max battery life): FHD (non-touch), Intel[®] i3-1315U, 8GB DDR4, Win 11, 63Wh battery, best power efficiency power mode

Alternate configuration 2: FHD (non-touch), Intel[®] i5-1350P, 16GB DDR4, Win 11, 57Wh battery, best power efficiency power mode

Alternate configuration 3: FHD (touch), Intel® i7-1360P, 64GB DDR4, NVIDIA® Geforce MX550, Win 11, 63Wh battery, best power efficiency power mode

All battery life claims are approximate maximum and based on results using <u>MobileMark® 25</u>, JEITA 2.0, continuous 1080p local video playback (using default Media Player in Fullscreen mode with 150nits brightness and default volume level), or Google Power Load Test (PLT) battery-life benchmark tests.

Actual battery life will vary depending on many factors such as product configuration, software, wireless functionality, power management settings, and screen brightness.

The maximum capacity of the battery will decrease with time, ambient temperature and use.

Refer to Microsoft[®] link for more information about the Windows[®] Performance power slider.

Power Adapter

Power Adapter**[1]

- 45W USB-C[®] (2-pin) AC adapter, supports PD 3.0, 100-240V, 50-60Hz
- 45W USB-C[®] (3-pin) AC adapter, supports PD 3.0, 100-240V, 50-60Hz
- 65W USB-C[®] (2-pin) AC adapter, supports PD 3.0, 100-240V, 50-60Hz
- 65W USB-C[®] (3-pin) AC adapter, supports PD 3.0, 100-240V, 50-60Hz
- 65W USB-C[®] slim (2-pin) AC adapter, supports PD 3.0, 100-240V, 50-60Hz
- * 65W USB-C* slim (3-pin) AC adapter, supports PD 3.0, 100-240V, 50-60Hz
- 100W USB-C[®] slim (3-pin) AC adapter, supports PD 3.0, 100-240V, 50-60Hz
- No power adapter^[2]

Notes:

[1] AC adapter offerings depend on the country.

[2] No power adapter is for special bid only.

DESIGN

Display

Display**

Size	Resolution	Touch	Туре	Brightness	Surface	Aspect Ratio	Contrast Ratio	Color Gamut	Refresh Rate	Viewing Angle (L/R/U/D)	Key Features
14″	HD (1366x768)	None	TN	220nits	Anti- glare	16:9	500:1	45% NTSC	60Hz	45° / 45° / 15° / 35°	-
14″	FHD (1920x1080)	None	IPS	250nits	Anti- glare	16:9	800:1	45% NTSC	60Hz	85° / 85° / 85° / 85°	-
14″	FHD (1920x1080)	Multi- touch	IPS	300nits	Anti- glare	16:9	1000:1	45% NTSC	60Hz	85° / 85° / 85° / 85°	-
14″	FHD (1920x1080)	None	IPS ^[1]	400nits	Anti- glare	16:9	1500:1	72% NTSC	60Hz	85° / 85° / 85° / 85°	Low power

Touchscreen

• On-cell multi-touch, supports 10-point touch

Non-touch

Notes:

[1] IPS (in-plane switching) technology may refer to IPS, PLS, ADS, AHVA, AAS.

Input Device

Keyboard

6-row, spill-resistant, multimedia Fn keys with Unified Communications controls

Keyboard Backlight

- LED backlight
- Non-backlight

UltraNav™

TrackPoint® pointing device and Mylar® surface multi-touch touchpad, 56 x 115 mm (2.24 x 4.53 inches)

Mechanical

Dimensions (WxDxH)[1]

Models	Dimensions
Aluminium (top), PC-CF (bottom) models	325.4 x 217 x 18.73 mm (12.81 x 8.54 x 0.74 inches)
Aluminium (top), PC-ABS (bottom) models	325.4 x 217 x 18.93 mm (12.81 x 8.54 x 0.75 inches)
PC-ABS (top), PC-CF (bottom) models	325.4 x 217 x 19.63 mm (12.81 x 8.54 x 0.77 inches)
PC-ABS (top), PC-ABS (bottom) models	325.4 x 217 x 19.83 mm (12.81 x 8.54 x 0.78 inches)

Weight^[2]

Starting at 1.4 kg (3.09 lbs)

Case Color

Thunder black

Case Material**

- Aluminium (top), PC-ABS (bottom)
- Aluminium (top), PC-CF (bottom)
- PC-ABS (top), PC-ABS (bottom)
- PC-ABS (top), PC-CF (bottom)

Notes:

[1] The system dimensions may vary depending on configurations.

[2] The system weight is approximate and based on results in Lenovo[®] lab, which varies depending on the source of component, variance of the distribution of each component, and manufacturing process. It may not be the exact weight for each specific model.

CONNECTIVITY

Network

Ethernet**

- Gigabit Ethernet, Intel® Ethernet Connection I219-LM (vPro® models), 1x RJ-45, supports Wake-on-LAN
- Gigabit Ethernet, Intel® Ethernet Connection I219-V (non-vPro® models), 1x RJ-45, supports Wake-on-LAN

WLAN + Bluetooth®**

- Intel[®] Wi-Fi[®] 6 AX201, 802.11ax 2x2 Wi-Fi[®] + Bluetooth[®] 5.2, M.2 Card^[1]
- Intel[®] Wi-Fi[®] 6E AX211, 802.11ax 2x2 Wi-Fi[®] + Bluetooth[®] 5.3, M.2 Card^[2]
- No WLAN and Bluetooth®

WWAN**

- Wireless WAN upgradable to 4G (with antenna ready)
- Quectel EM05-G, 4G LTE CAT4, M.2 card, with embedded eSIM functionality
- Fibocom L860-GL-16, 4G LTE CAT16, M.2 card, with embedded eSIM functionality
- No support

SIM Card

No physical SIM card inbox

NFC

- Near Field Communication
- No support

Notes:

[1] Wi-Fi[®] 6 full features might be limited by country-level restrictions.

Bluetooth[®] 5.2 is hardware ready but may run at a lower version due to OS limitations.

[2] Wi-Fi® 6E full features might be limited by country-level restrictions.

Wi-Fi® 6E is only enabled on Windows® 11 and operates as Wi-Fi® 6 with Windows® 10.

6GHz Wi-Fi® 6E operation is dependent on the support of the operating system, routers/APs/Gateways that support Wi-

Fi® 6E, and the regional regulatory certifications & spectrum allocation.

Bluetooth[®] 5.3 operation requires Windows[®] 11. For more information please visit <u>General Bluetooth[®] Support Information</u> <u>on Microsoft[®]</u>.

Ports^[1]

Standard Ports

- 1x USB 3.2 Gen 1
- 1x USB 3.2 Gen 1 (Always On)
- 1x USB-C[®] 3.2 Gen 2 (support data transfer, Power Delivery 3.0 and DisplayPort[™] 1.4)
- 1x Thunderbolt[™] 4 / USB4[®] 40Gbps (support data transfer, Power Delivery 3.0 and DisplayPort[™] 1.4)
- 1x HDMI[®] 2.1, up to 4K/60Hz
- 1x Headphone / microphone combo jack (3.5mm)
- 1x Ethernet (RJ-45)
- 1x microSD card reader

Optional Ports***

- 1x Smart card reader
- 1x Nano-SIM card slot (WWAN support models)

Notes:

[1] The transfer speed of following ports will vary and, depending on many factors, such as the processing speed of the host device, file attributes and other factors related to system configuration and your operating environment, will be slower than theoretical speed.

USB 2.0: 480 Mbit/s;

USB 3.2 Gen 1 (SuperSpeed USB 5Gbps, formerly USB 3.0 / USB 3.1 Gen 1): 5 Gbit/s;

USB 3.2 Gen 2 (SuperSpeed USB 10Gbps, formerly USB 3.1 Gen 2): 10 Gbit/s;

USB4[®] 20Gbps / USB 3.2 Gen 2x2 (SuperSpeed USB 20Gbps): 20 Gbit/s;

USB4[®] 40Gbps (USB 40Gbps): 40 Gbit/s;

Thunderbolt™ 3/4: 40 Gbit/s.

Docking

Docking

Various docking solutions supported via Thunderbolt[™] or USB-C[®]. For more compatible docking solutions, please visit <u>Docking for ThinkPad[®] L14 Gen 4 (Intel[®])</u>

SECURITY & PRIVACY

Security

Security Chip

Discrete TPM 2.0, TCG certified, FIPS 140-2 certified

Physical Locks

Kensington[®] Nano Security Slot[™], 2.5 x 6 mm

Smart Card Reader

- Smart card reader, supports ISO 7816 and EMV
- No smart card reader

Fingerprint Reader

- Touch style fingerprint reader integrated in power button, match-on-chip
- No fingerprint reader

BIOS Security

- Supervisor password
- Power-on password
- NVMe® password
- Self-healing BIOS

Other Security

- (Optional) IR camera for Windows® Hello (facial recognition)
- Camera privacy shutter

MANAGEABILITY

System Management

System Management**

- Intel[®] vPro[®] Enterprise^[1]
- Intel[®] vPro[®] Essentials^[2]
- Non-vPro®

Notes:

[1], [2] Intel[®] vPro[®] offers a superset of DASH's defined capabilities.

SERVICE

Warranty

Base Warranty**

- 1-year courier or carry-in service
- 1-year courier or carry-in with 2-year system board service (Korea only)
- 1-year limited onsite service
- 3-year (1-yr battery) courier or carry-in service
- 3-year (1-yr battery) limited onsite service

ACCESSORIES

Bundled Accessories

Bundled Accessories***[1]

- Lenovo[®] HDMI[®] to VGA Monitor Adapter
- Lenovo[®] USB-C[®] to DisplayPort[™] Adapter
- Lenovo® USB-C® to VGA Adapter
- None

Notes:

[1] For more compatible accessory solutions, please visit Accessories for ThinkPad® L14 Gen 4 (Intel®).

OPERATING REQUIREMENTS

Operating Environment

Temperature^[1]

- Operating: 5°C (41°F) to 35°C (95°F)
- Storage and transportation in original shipping package: -20°C (-4°F) to 60°C (140°F)
- Storage without package: 5°C (41°F) to 43°C (109°F)

Relative Humidity

- Operating: 8% to 95% at wet-bulb temperature 23°C (73°F)
- Storage and transportation: 5% to 95% at wet-bulb temperature 27°C (81°F)

Altitude

Maximum altitude (without pressurization): 3048 m (10,000 ft)

Notes:

[1] When you charge the battery, its temperature must be no lower than 10°C (50°F).

ENVIRONMENTAL

Sustainability

Material

30% PCC recycled plastic used in top cover frame material 50% PCC recycled plastic used in speaker enclosure 90% PCC recycled plastic used in the battery pack enclosure 90% PCC recycled plastic used in standard adapter 45% PCC recycled plastic used in SIM tray Low-temperature solder 90% recycled and/or sustainable packaging

CERTIFICATIONS

Green Certifications^{III}

Green Certifications^[2]

- ENERGY STAR[®] 8.0
- EPEAT[™] Gold Registered^[3]
- ErP Lot 6/26
- RoHS compliant
- TCO Certified 9.0

Notes:

[1] The items listed under the "Green Certifications" section may not only refer to certification but also registration or self-declaration. For ESG & regulatory compliance documents, please visit <u>https://compliance.lenovo.com</u>.
[2] EPEAT™ registration and ENERGY STAR® certification are optional and only available on the models with preloaded OS. Please visit <u>epeat.net</u> and <u>energystar.gov</u> for more information.
[3] EPEAT™ registered where applicable, please visit <u>epeat.net</u> for registration status by country.

Other Certifications

Mil-Spec Test

MIL-STD-810H military test passed

- Feature with ** means that only one offering listed under the feature is configured on selected models.
- Feature with *** means that one or more offerings listed under the feature could be configured on selected models.
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